

This listing of claims will replace all prior versions, and listings, of claims in the application.

**Listing of Claims:**

- 1-8. (canceled)
9. (withdrawn) A method of making an epoxy sight bowl comprising:  
  
    obtaining a molded filler-less epoxy compound;  
  
    pre-stressing said filler-less epoxy compound; and  
  
    heating said filler-less epoxy compound for a time sufficient for said molded  
filler-less epoxy compound to near a fully cured state.
10. (canceled)
11. (canceled)
12. (withdrawn) The method of claim 9 wherein said molded filler-less epoxy  
compound comprises a cycloaliphatic epoxy compound.
13. (withdrawn) The method of claim 12 wherein said molded filler-less epoxy  
compound is anhydride cured.
14. (withdrawn) The method of claim 13 wherein said molded filler-less epoxy  
compound contains ultraviolet light absorbers.

15. (withdrawn) The method of claim 9 wherein said pre-stressing comprises placing said molded filler-less epoxy compound under pressurized conditions.

16. (withdrawn) The method of claim 15 wherein said molded filler-less epoxy compound comprises a cycloaliphatic epoxy compound.

17. (withdrawn) The method of claim 14 wherein said heating comprises exposing said molded filler-less epoxy compound to 150°C for at least twelve hours.

18. (withdrawn) The method of claim 16 wherein said heating comprises subjecting said molded filler-less epoxy compound to a temperature of 105°C or above.

19. (withdrawn) The method of claim 14 wherein said pre-stressing comprises placing said molded filler-less epoxy compound under a pressure of about 2,500 psi and wherein said heating comprises:

subjecting said molded filler-less epoxy compound to 105°C heat for at least forty eight hours;

cooling said molded filler-less epoxy compound;

subjecting said molded filler-less epoxy compound to 105°C heat for at least forty eight hours;

cooling said molded filler-less epoxy compound; and

subjecting said molded filler-less epoxy compound to 105°C heat for at least forty eight hours.

20. (withdrawn) The method of claim 12 wherein said pre-stressing comprises placing said molded filler-less epoxy compound under a pressure of about 2,500 psi and wherein said heating comprises subjecting said molded filler-less epoxy compound to 125°C heat for at least twelve hours.

21. (currently amended) A power transformer, comprising:

a transformer tank;

a bushing coupled to said transformer tank; and

a sight bowl housed in said bushing, said sight bowl being transparent and comprising a cured ~~and filler-less~~ epoxy compound.

22. (previously presented) The power transformer of claim 21 wherein said sight bowl is cylindrical.

23. (previously presented) The power transformer of claim 21 wherein said cured and filler-less epoxy compound comprises a cycloaliphatic epoxy compound.

24. (previously presented) The power transformer of claim 23 wherein said cured and filler-less epoxy compound is anhydride cured.

25. (previously presented) The power transformer of claim 24 wherein said cured and filler-less epoxy compound contains ultraviolet light absorbers.

26. (currently amended) A bushing for a power transformer, comprising a sight bowl housed in said bushing, said sight bowl being transparent and comprising a cured ~~and filler-~~less epoxy compound.

27. (previously presented) The bushing of claim 26 wherein said sight bowl is cylindrical.

28. (previously presented) The bushing of claim 26 wherein said cured and filler-less epoxy compound comprises a cycloaliphatic epoxy compound.

29. (previously presented) The bushing of claim 28 wherein said cured and filler-less epoxy compound is anhydride cured.

30. (previously presented) The bushing of claim 29 wherein said cured and filler-less epoxy compound contains ultraviolet light absorbers.